

**BUZ900X4S
BUZ901X4S**

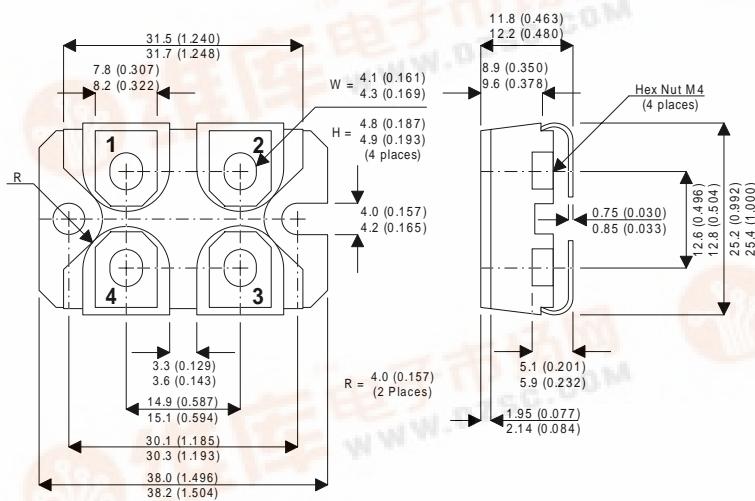
NEW PRODUCT UNDER DEVELOPMENT

MECHANICAL DATA

Dimensions in mm (inches)

N-CHANNEL POWER MOSFET

POWER MOSFETS FOR AUDIO APPLICATIONS



SOT227

Pin 1 – Drain
Pin 2 – Source
Pin 3 – Gate
Pin 4 – Drain

FEATURES

- HIGH SPEED SWITCHING
- N-CHANNEL POWER MOSFET
- SEMEFAB DESIGNED AND DIFFUSED
- HIGH VOLTAGE (160V & 200V)
- HIGH ENERGY RATING
- ENHANCEMENT MODE
- INTEGRAL PROTECTION DIODE
- P-CHANNEL ALSO AVAILABLE

ABSOLUTE MAXIMUM RATINGS

($T_{case} = 25^\circ\text{C}$ unless otherwise stated)

		BUZ900X4S	BUZ901X4S
V_{DSX}	Drain – Source Voltage	160V	200V
V_{GS}	Gate – Source Voltage	$\pm 14\text{V}$	
I_D	Continuous Drain Current	32A	
$I_{D(PK)}$	Body Drain Diode	32A	
P_D	Total Power Dissipation @ $T_{case} = 25^\circ\text{C}$	500W	
T_{stg}	Storage Temperature Range	-55 to 150°C	
T_j	Maximum Operating Junction Temperature	150°C	
$R_{\theta JC}$	Thermal Resistance Junction – Case	0.3°C/W	



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ELECTRICAL RATINGS ($T_{case} = 25^\circ C$ unless otherwise stated)

Characteristic	Test Conditions		Min.	Typ.	Max.	Unit
BV_{DSX}	$V_{GS} = -10V$	BUZ900X4S	160			V
	$I_D = 10mA$	BUZ901X4S	200			
BV_{GSS}	$V_{DS} = 0$	$I_G = \pm 100\mu A$	± 14			V
$V_{GS(OFF)}$	$V_{DS} = 10V$	$I_D = 100mA$	0.1		1.5	V
$V_{DS(SAT)}^*$	$V_{GD} = 0$	$I_D = 32A$			12	V
I_{DSX}	$V_{GS} = -10V$					
	$V_{DS} = 160V$	BUZ900X4S			10	mA
	$V_{DS} = 200V$	BUZ901X4S			10	mA
y_{fs}^*	$V_{DS} = 10V$	$I_D = 5A$	2		6	S
C_{iss}	Input Capacitance			TBE		pF
C_{oss}	$V_{DS} = 10V$			TBE		
C_{rss}	$f = 1MHz$			TBE		
t_{on}	Turn-on Time			TBE		nS
t_{off}	$V_{DS} = 20V$		$I_D = 7A$	TBE		

* Pulse Test: Pulse Width = $300\mu S$, Duty Cycle $\leq 2\%$

